



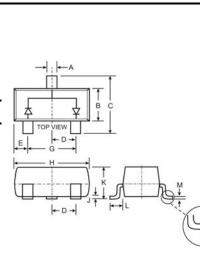
# DUAL SURFACE MOUNT SWITCHING DIODE

### **Features**

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

# Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)



SOT-23								
Dim	Min	Max						
Α	0.37	0.51						
В	1.20	1.40						
С	2.30	2.50						
D	0.89	1.03 0.60						
Е	0.45							
G	1.78	2.05						
Н	2.80	3.00 0.10 1.10						
J	0.013							
к	0.903							
L	0.45	0.61						
N	0.085	0.180						
α	0°	8°						
All Din	nensions	in mm						

# **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit		
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	100	V		
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	v		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	53	V		
Forward Continuous Current (Note 1)	I <sub>FM</sub>	300	mA		
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs   @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	А		
Power Dissipation (Note 1)	P <sub>d</sub>	350	mW		
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ ext{ heta}JA}$	357	°C/W		
Operating and Storage Temperature Range	T <sub>i</sub> , T <sub>STG</sub>	-65 to +150	°C		

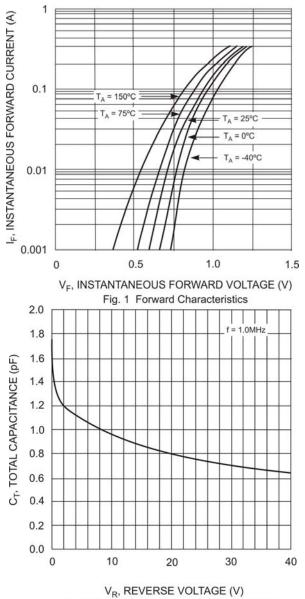
# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

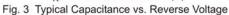
Characteristic	Symbol	Min	Мах	Unit	Test Condition		
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	75	_	V	I <sub>R</sub> = 2.5μA		
Forward Voltage	V <sub>F</sub>	_	0.715 0.855 1.0 1.25	v	$\begin{array}{l} I_F = 1.0mA\\ I_F = 10mA\\ I_F = 50mA\\ I_F = 150mA \end{array}$		
Reverse Current (Note 2)	I <sub>R</sub>	_	2.5 50 30 25	μΑ μΑ μΑ nA	$ \begin{array}{l} V_{R} = 75V \\ V_{R} = 75V, \ T_{i} = 150^{\circ}C \\ V_{R} = 25V, \ T_{i} = 150^{\circ}C \\ V_{R} = 20V \end{array} $		
Total Capacitance	Ст	_	2.0	pF	$V_{R} = 0, f = 1.0MHz$		
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$		

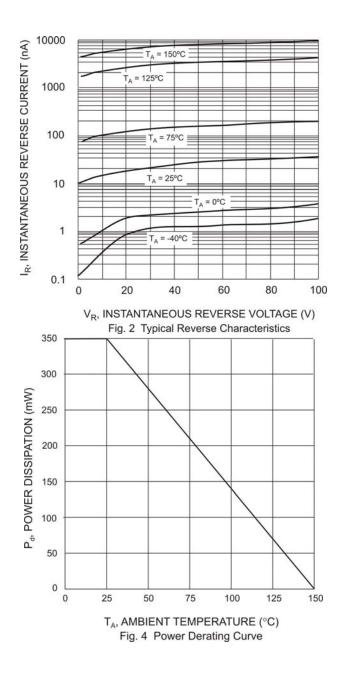
Notes: 1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 2. Short duration test pulse used to minimize self-heating effect.

3. No purposefully added lead.









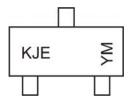


# Ordering Information (Note 4)

Device	Packaging	Shipping			
BAV99-7-F	SOT-23	3000/Tape & Reel			

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# Marking Information



KJE = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	К	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Fe	b I	Mar	Apr	Мау	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		Ν	D

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